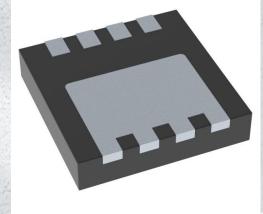


FDMC86184 Datasheet

www.digi-electronics.com



DiGi Electronics Part Number	FDMC86184-DG
Manufacturer	onsemi
Manufacturer Product Number	FDMC86184
Description	MOSFET N-CH 100V 57A 8PQFN
Detailed Description	N-Channel 100 V 57A (Tc) 54W (Tc) Surface Mount 8 -PQFN (3.3x3.3)

https://www.DiGi-Electronics.com



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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FDMC86184	onsemi
Series:	Product Status:
PowerTrench®	Active
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (ld) @ 25°C:
100 V	57A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
6V, 10V	8.5mOhm @ 21A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
4V @ 110µA	20 nC @ 6 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	2090 pF @ 50 V
FET Feature:	Power Dissipation (Max):
	54W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
8-PQFN (3.3x3.3)	8-PowerWDFN
Base Product Number:	
FDMC86	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	

onsemi

MOSFET – N-Channel, Shielded Gate, POWER TRENCH[®]

100 V, 57 A, 8.5 m Ω

FDMC86184

Description

This N-Channel logic MV MOSFETs is produced using onsemi advanced POWERTRENCH process that incorporates Shielded Gate technology. This process has been optimized to minimize on-state resistance and yet maintain superior switching performance with best in class soft body diode.

Features

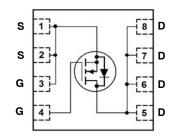
- Shielded Gate MOSFET Technology
- Max $R_{DS(on)} = 8.5 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 21 \text{ A}$
- Max $R_{DS(on)} = 24.8 \text{ m}\Omega$ at $V_{GS} = 6.5 \text{ V}$, $I_D = 10 \text{ A}$
- 50% Lower Qrr than Osther MOSFET Supplier
- Lowers Switching Noise/EMI
- MSL1 Robust Package Design
- 100% UIL Tested
- ESD Protection Level : HBM>1kV, CDM>2kV
- These Device is Pb-Free and RoHS Compliant

Typical Applications or Applications

- Primary DC-DC MOSFET
- Synchronous Rectifier in DC–DC and AC–DC
- Motor Drive
- Solar



WDFN8 3.3X3.3, 0.65P CASE 483AW



MARKING DIAGRAM



FDMC86184 = Specific Device Code A = Assembly Location Y = Year

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]
FDMC86184	PQFN-8	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

MOSFET MAXIMUM RATINGS T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Unit	
V _{DS}	Drain to Source Voltage	100	V	
V _{GS}	Gate to Source Voltage	±20	V	
Ι _D	Drain Current -Continuous ($T_A = 25^{\circ}C$) (Note 5) -Continuous ($T_A = 100^{\circ}C$) (Note 5) -Continuous ($T_A = 25^{\circ}C$) (Note 1) -Pulsed (Note 4)	57 36 12 266	A	
E _{AS}	Single Pulse Avalanche Energy (Note 3)	121	mJ	
P _D	Power Dissipation ($T_c = 25^{\circ}C$) Power Dissipation ($T_A = 25^{\circ}C$) (Note 1)	54 2.3	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range	–55 to +150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

FDMC86184 onsemi MOSFET N-CH 100V 57A 8PQFN

FDMC86184

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		°C/W
R_{\thetaJA}			

ELECTRICAL CHARACTERISTICS T_J = 25 °C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Characteri	stics	· · · ·			•	
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	100	-	-	V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25°C	-	59	-	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V	_	-	1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V	-	-	100	nA
On Characteri	stics					
V _{GS(th)}	Gate to Source Threshold Voltage	V_{GS} = V_{DS} , I_D = 110 μ A	2.0	3.1	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 110 μ A, referenced to 25 °C	-	-9	-	mV/°C
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 21 A	-	6.4	8.5	mΩ
		V _{GS} = 6 V,I _D = 10 A	-	11	24.8	1
		V_{GS} = 10 V, I _D = 21 A, T _J = 125 °C	-	11	18	
9 FS	Forward Transconductance	V _{DS} = 5 V, I _D = 21 A	-	49	-	S
Dynamic Char	acteristics					
C _{iss}	Input Capacitance	V_{DS} = 50 V, V_{GS} = 0 V, f = 1 MHz	-	1490	2090	pF
C _{oss}	Output Capacitance		-	906	1270	pF
C _{rss}	Reverse Transfer Capacitance		-	13	25	pF
Rg	Gate Resistance		0.1	0.4	1.2	Ω
Switching Cha	aracteristics					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 21 \text{ A},$	-	12	22	ns
t _r	Rise Time	$V_{GS} = 10 \text{ V}, \overline{R}_{GEN} = 6 \Omega$	-	4	10	ns
t _{d(off)}	Turn-Off Delay Time		-	17	31	ns
t _f	Fall Time] [-	4	10	ns
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V,$ $V_{DD} = 50 V, I_D = 21 A$	-	21	30	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V,$ $V_{DD} = 50 V, I_D = 21 A$	-	14	20	nC
Q _{gs}	Total Gate Charge	V _{DD} = 50 V, I _D = 21 A	-	6.5	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	V _{DD} = 50 V, I _D = 21 A	-	4.6	-	nC
Q _{oss}	Output Charge	V _{DD} = 50 V, V _{GS} = 0 V	_	61	-	nC



FDMC86184 onsemi MOSFET N-CH 100V 57A 8PQFN

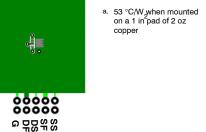
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ELECTRICAL CHARACTERISTICS (continued) T_J = 25 °C unless otherwise noted.

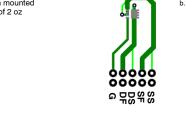
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Drain-Source	Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 2.1 A (Note 2)	-	0.7	1.2	V
		V _{GS} = 0 V, I _S = 21 A (Note 2)	-	0.8	1.3	
t _{rr}	Reverse Recovery Time	I _F = 10 A, di/dt = 300 A/μs	-	27	44	ns
Q _{rr}	Reverse Recovery Charge		-	46	74	nC
t _{rr}	Reverse Recovery Time	I _F = 10 A, di/dt = 1000 A/μs	-	21	34	ns
Q _{rr}	Reverse Recovery Time		-	96	154	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material $R_{\theta CA}$ is determined by the

user's board design.



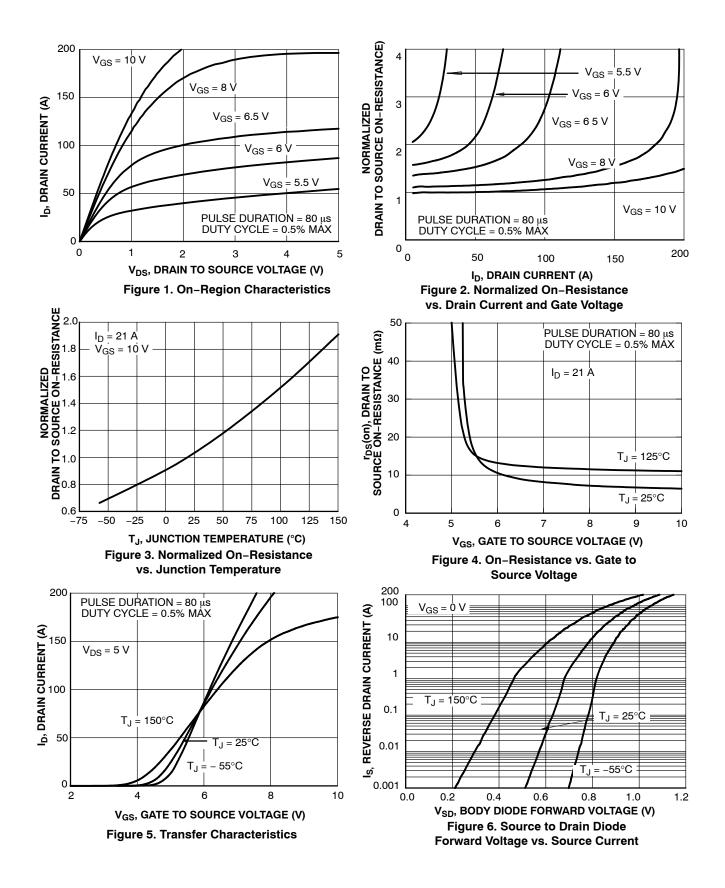
- Pulse Test : Pulse Width < 300 us, Duty Cycle < 2.0%
 E_{AS} of 121 mJ is based on starting T_J = 25 °C; N-ch: L = 3 mH, I_{AS} = 9 A, V_{DD} = 100 V, V_{GS} =10 V. 100% test at L = 0.3 mH, I_{AS} = 21 A.
 Pulsed ld please refer to Figure 11 SOA graph for more details.
 Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electron provide the electro-mechanical application board design.



b. 125 °C/W when mounted on a minimum pad of 2 oz copper

FDMC86184

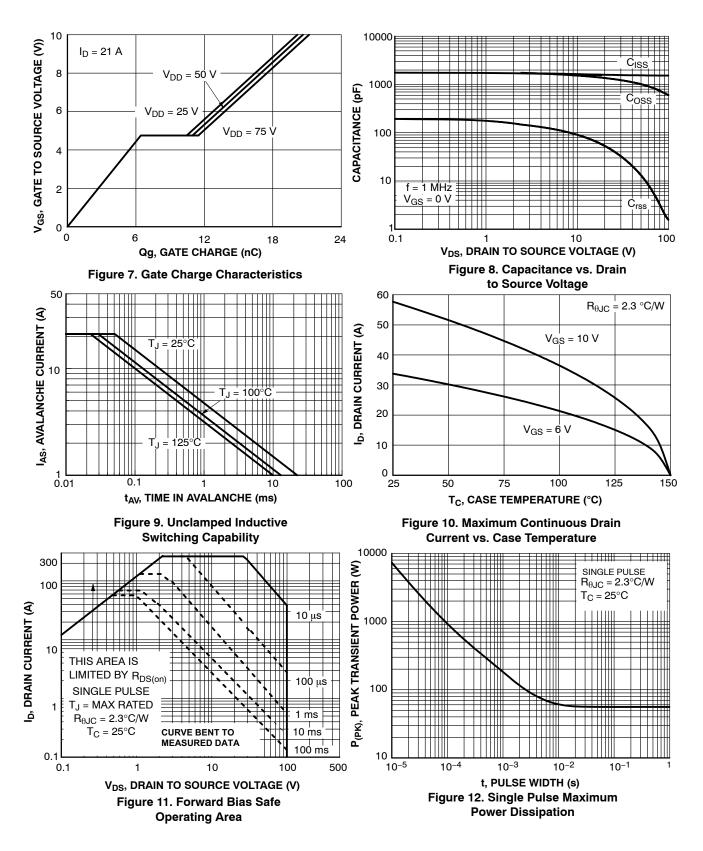
TYPICAL CHARACTERISTICS





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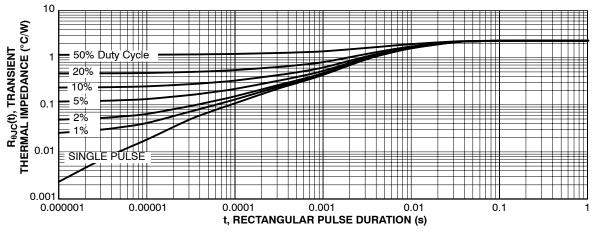
TYPICAL CHARACTERISTICS (CONTINUED)





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TYPICAL CHARACTERISTICS (CONTINUED)





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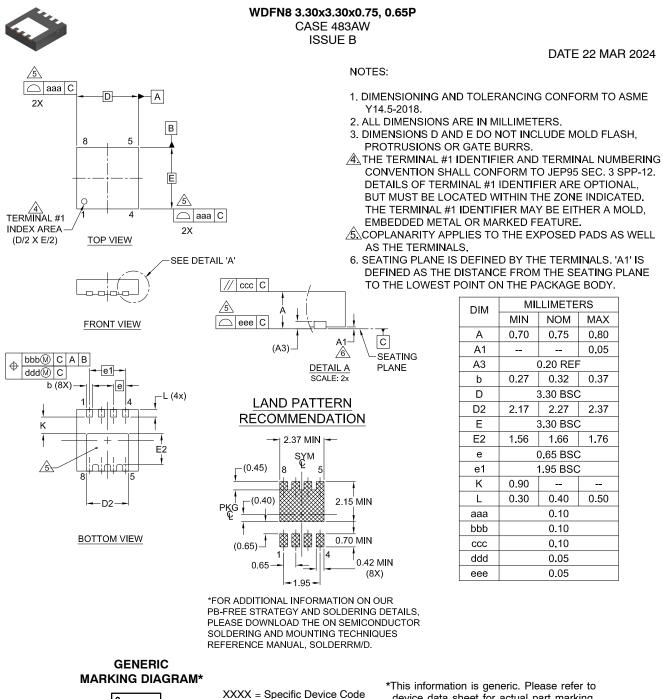




ONSEMÍ...

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





XXXX	= Specific Device Code
А	= Assembly Location
Y	= Year
WW	= Work Week

This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	WDFN8 3.30x3.30x0.75, 0.6	55P	PAGE 1 OF 1

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